ZXCT1041
Bidirectional precision high-side current monitor

Description

The ZXCT1041 is a bidirectional precision high-side current sense monitor. The output voltage is proportional to the differential input voltage. Direction of current flow is indicated by the Flag pin.

The ZXCT1041 provides a fixed gain of 10 for applications where minimal external components are required.

The very low offset voltage enables a typical accuracy of 2% for sense voltages of only 10mV, giving better tolerances for small sense resistors necessary at higher currents.

The wide input voltage range of 20V down to as low as 2.7V make it suitable for a range of applications.

A minimum operating current of just 40μA, combined with a SOT23-5 package makes the ZXCT1041 particularly suitable for portable battery equipment.

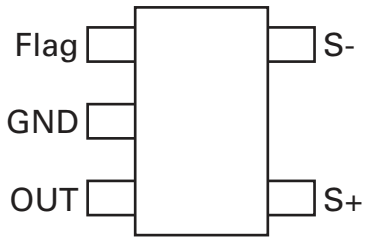
Features

- Bidirectional high side measurement
- Output voltage scaling x10
- 2.7V to 20V high side voltage
- 35μA quiescent current
- 1% typical accuracy
- SOT23-5 package

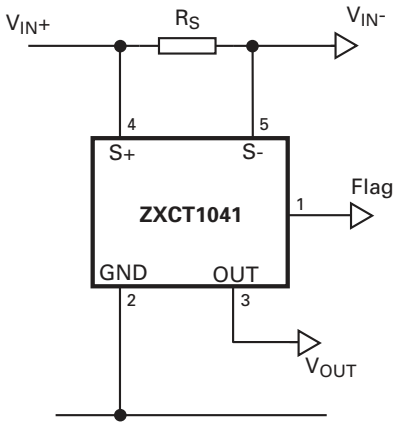
Applications

- Battery management
- Over current monitor
- Battery gas gauging
- Motor control

Pin connections



Typical application circuit



Ordering information

Order code	Package	Partmark	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXCT1041E5TA	SOT23-5	1041	7	8	3000

Absolute maximum ratings

Voltage on V_{S-} and V_{S+}	-0.6 to 20V
Voltage on all other pins	-0.6V to (V_{S+} or V_{S-}) +0.6V
V_{sense} [(V_{S+}) - (V_{S-})]	+/-6V
Operating temperature, T_A	-40 to 125°C
Storage temperature	-55 to 150°C
Maximum junction temperature, T_J	150°C
Package power dissipation	300mW at T_A = 25°C (De-rate to zero at 150°C)

Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

Recommended operating conditions

Parameter		Min.	Max.	Units
$V_{S\pm}$	Common-mode sense input range	2.7	20	V
Flag	Current direction flag output	0	$V_{S\pm}$	V
V_{SENSE}	Differential sense input voltage range	0	±0.8	V
V_{OUT}	Output voltage range	0	$V_{S\pm}$ -1.5	V
T_A	Ambient temperature range	-40	125	°C

Pin function table

Pin	Name	Description
1	Flag	This is the current direction pin. It is open collector and allows the logic high level to be set independent of V_{S+} voltage. Low indicates V_{S+} is greater than V_{S-}
2	GND	Ground pin
3	OUT	Output voltage pin
4	S+	This is the positive input of the current monitor. It also acts as the supply voltage pin providing current for internal circuitry. The current through this pin varies with differential sense voltage
5	S-	This is the negative input of the current monitor. The current through this pin varies with differential sense voltage

Electrical characteristics

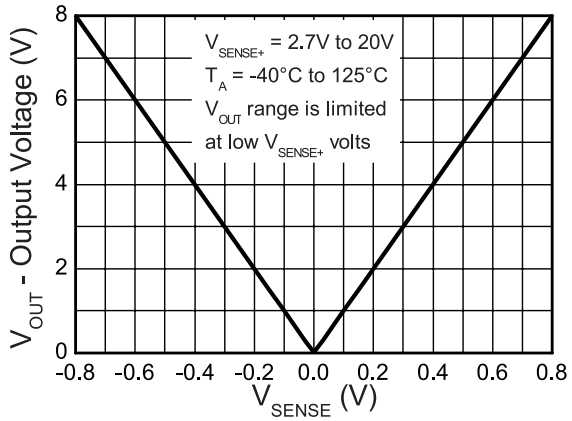
Test conditions T_A = 25°C, V_{S+} = 10V, V_{SENSE} = 100mV

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
I_Q	Ground pin current		15	35	50	µA
I_{S+}	V_{S+} input current	V_{SENSE} = 0V	10	17	24	µA
I_{S-}	V_{S-} input current	V_{SENSE} = 0V	10	17	24	µA
V_{OUT}	Output voltage [flag high]	V_{SENSE} = +150mV	1.55	1.5	1.45	V
		V_{SENSE} = +100mV	1.02	1	0.98	V
		V_{SENSE} = +30mV	309	300	291	mV
		V_{SENSE} = 0V	0		15	mV
	[flag low]	V_{SENSE} = -30mV	285	300	315	mV
		V_{SENSE} = -100mV	0.95	1	1.05	V
		V_{SENSE} = -150mV	1.42	1.50	1.58	V
V_{OUT} TC	V_{OUT} variation with temperature	V_{SENSE} = ±100mV		30		ppm/°C
Gain	V_{OUT}/V_{SENSE}			10		
Accuracy	Total output error (Gain + offset)	V_{SENSE} = 100mV			±2	%
Accuracy	Total output error (Gain + offset)	V_{SENSE} = -100mV			±5	%
BW	Bandwidth	$V_{SENSE(DC)}$ = 100mV $V_{SENSE(AC)}$ = 63mV_{PP}		300		kHz
CMRR	V_{S+} common mode rejection ratio	V_{IN} = 2.7 to 20V		60		dB
Flag TP	Flag trip point	Referred to V_{SENSE}	-2.5		+2.5	mV
V_{FL}	Flag low output voltage	I_{SINK} = 100µA		60	200	mV
I_{FH}	Flag high leakage current	V_{OH} = 5V			1	µA

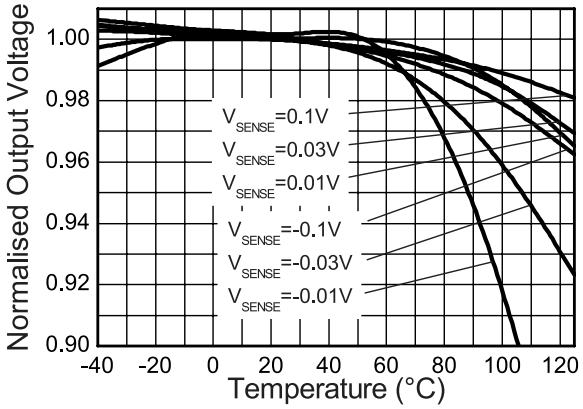
NOTES:
(a) V_{SENSE} = "V_{S+}" - "V_{S-}"
(b) Temperature dependent measurements are extracted from characterisation and simulation results.

Typical characteristics

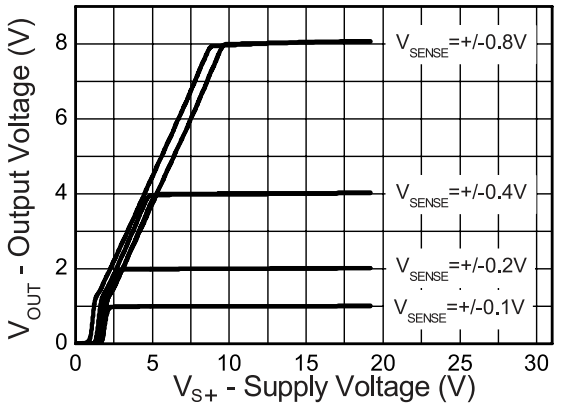
Conditions V_{SENSE}+=10V, V_{SENSE}=100mV, T_A=25°C unless otherwise stated.



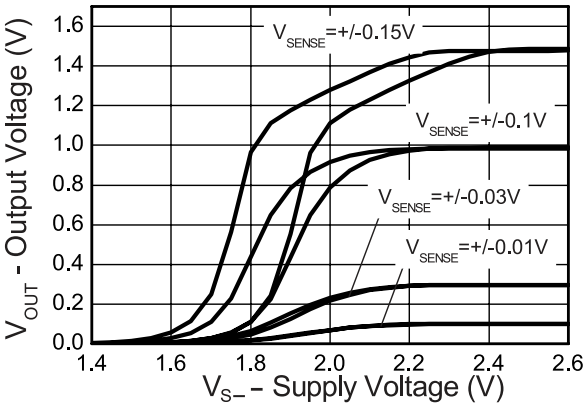
Output Voltage v Sense Voltage



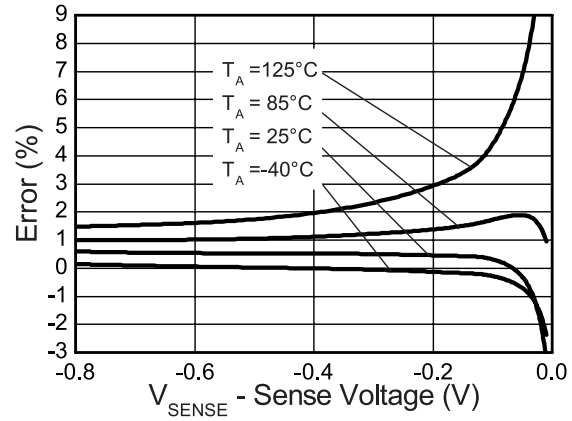
Output v Temperature



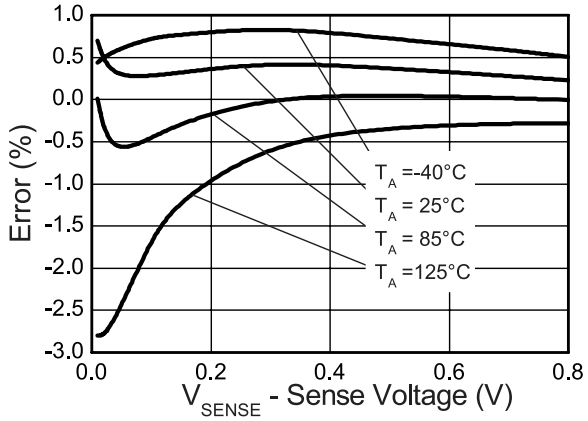
Output v Supply Voltage



Output v Supply Voltage



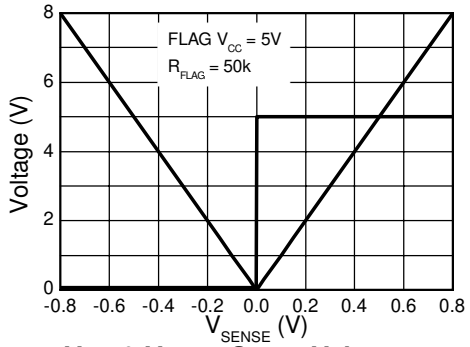
Error v Reverse Sense Voltage



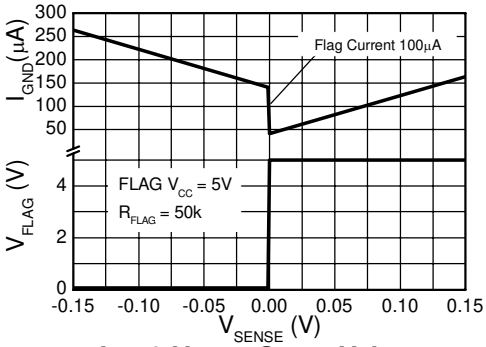
Error v Forward Sense Voltage

Typical characteristics

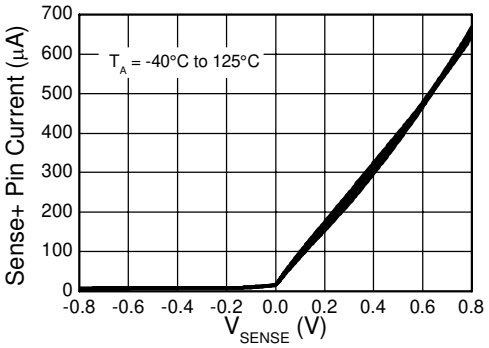
Conditions V_{SENSE}+=10V, V_{SENSE}=100mV, T_A=25°C unless otherwise stated.



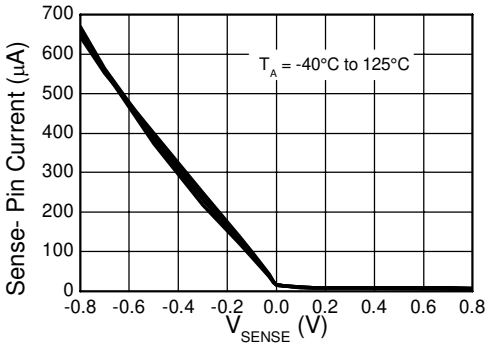
V_{OUT} & V_{FLAG} v Sense Voltage



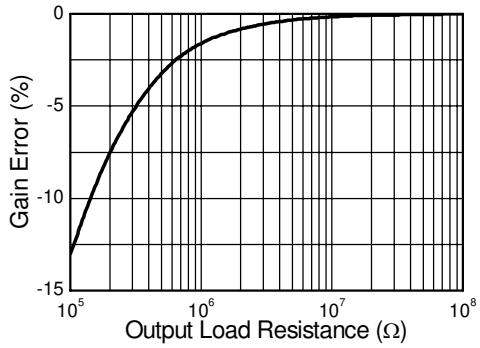
I_{GND} & V_{FLAG} v Sense Voltage



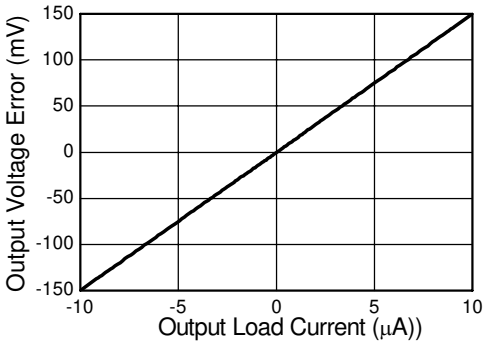
I_{SENSE+} v Sense Voltage



I_{SENSE-} v Sense Voltage



Error v Resistive Loading



Error v Current Loading

Typical characteristics

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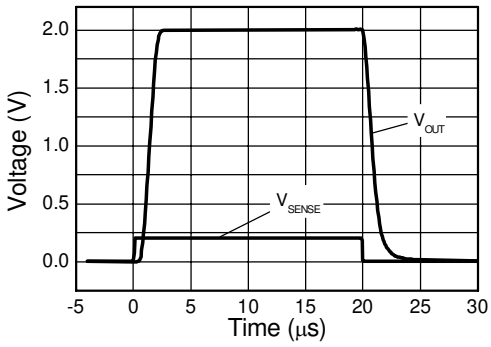
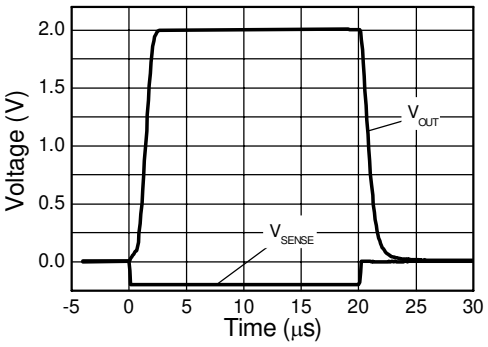
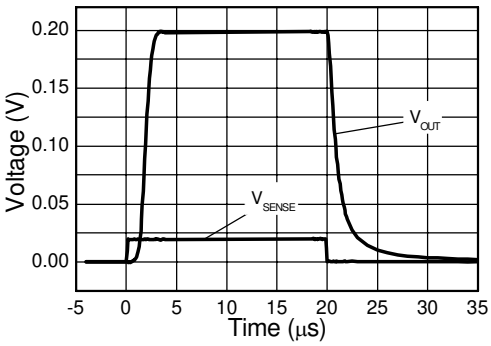


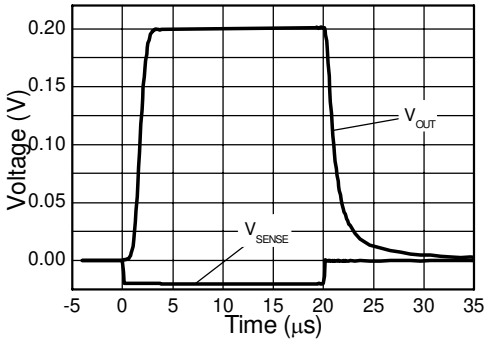
Forward Large Signal Step Response



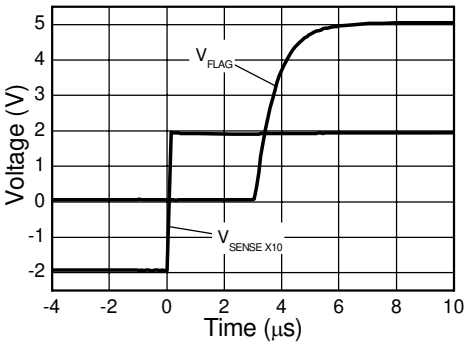
Reverse Large Signal Step Response



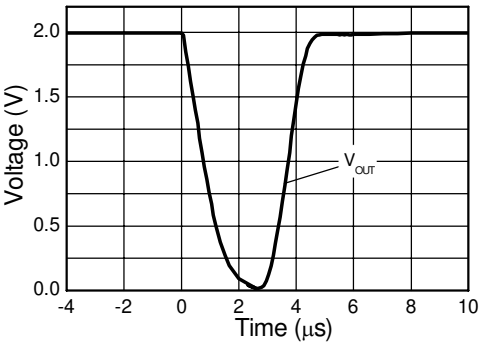
Forward Small Signal Step Response



Reverse Small Signal Step Response



Large Sig Zero Crossing Response



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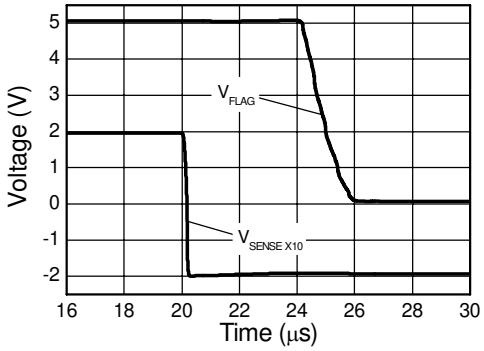

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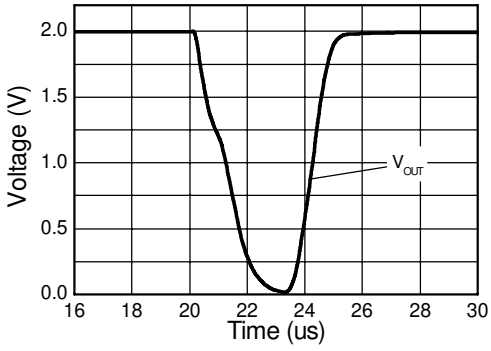

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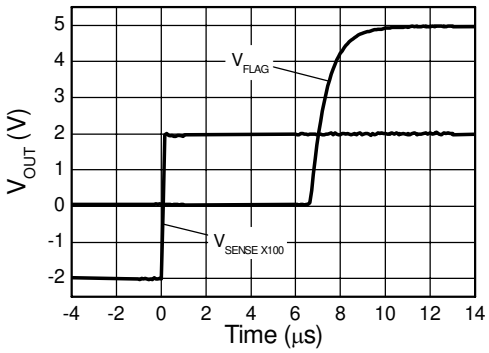
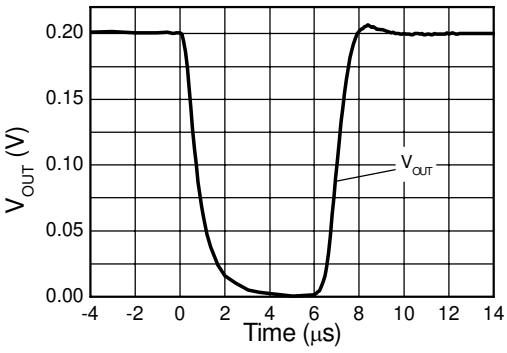


Small Sig Zero Crossing Response



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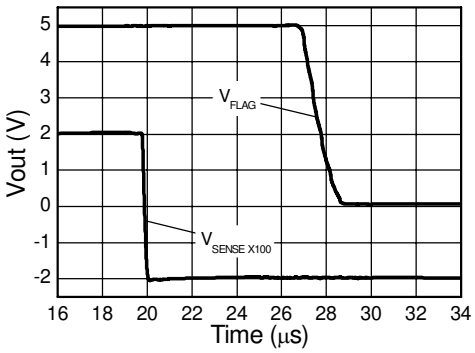
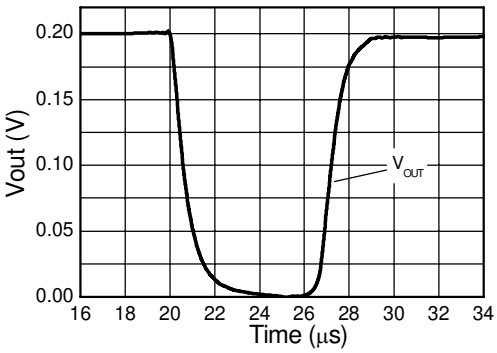


Small Sig Zero Crossing Response



Small Sig Zero Crossing Response

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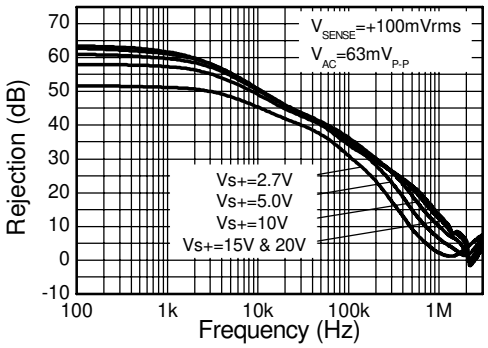
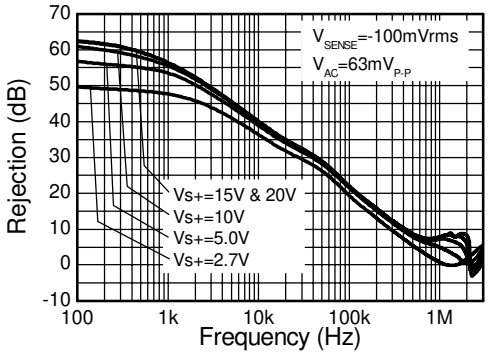
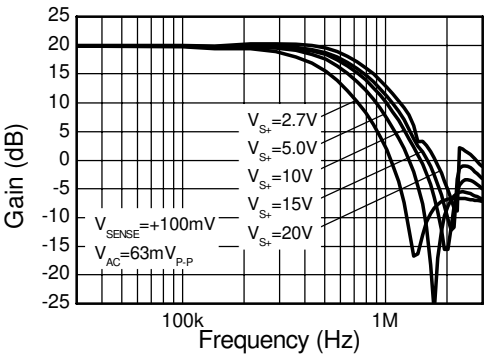


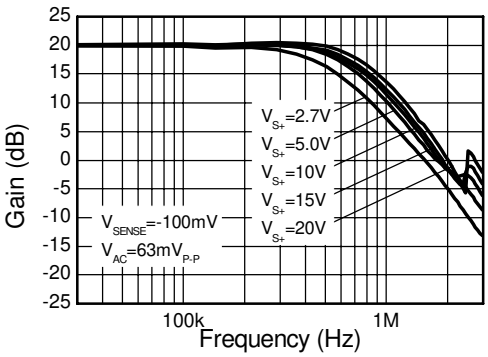
Forward CMRR



Reverse CMRR



Forward Frequency Response



Reverse Frequency Response

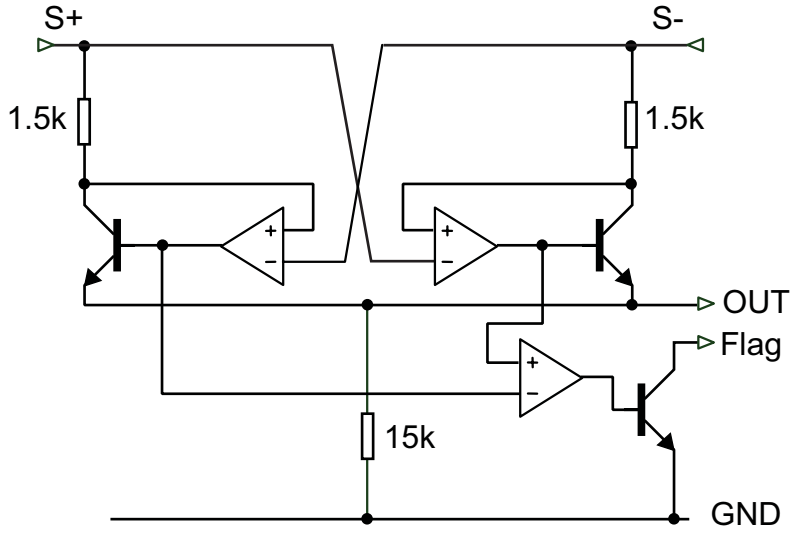
Application information

The ZXCT1041 uses two current monitors in anti-parallel to provide bidirectional current measurement. The integrated resistors while having a broad actual value variance provide very good matching to one another; this provides very tight gain matching from forward current measurement to reverse current management and removes the need to trim the resistor values.

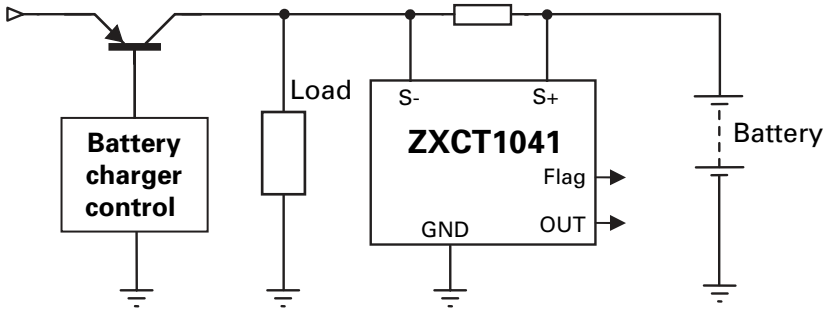
The internal transconductance setting resistors have a nominal value of 1.5kΩ thereby setting the internal transconductance to 0.67mA/V of V_{SENSE-}. The outputs of both current monitors (current) are summed into an internal common gain-setting resistor of 15kΩ. This sets the overall gain to 10 which has a very small variance due to the very good matching of internal transistors.

To improve accuracy the offset of amplifier 1 is trimmed.

The direction of measured current flow is determined by comparing the voltages applied to the bases of transconductance transistors (Q1 and Q2). For maximum versatility the flag output uses an open collector; this allows the ZXCT1041 to monitor rails at a much higher potential than what the flag output is interfacing to.



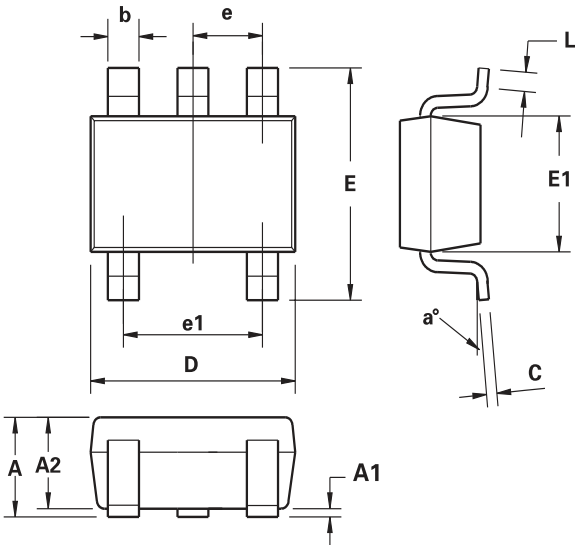
A common application for micro-power current monitors is measuring the discharge current of a rechargeable lithium ion/polymer battery. The ZXCT1041 enables measuring both the charge and discharge current into the battery and with its wide operating voltage of 2.5 to 20V enables it to measure the currents in to/ out of up to 4 cells connected in series.



When choosing appropriate values for R_{SENSE} a compromise must be reached between in-line signal loss (including potential power dissipation effects) and small signal accuracy.

Higher values for R_{SENSE} gives better accuracy at low load currents by reducing the inaccuracies due to internal offsets. For best operation the ZXCT1041 has been designed to operate with V_{SENSE} of the order of 50mV to 150mV.

Package outline - SOT23-5



DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.90	1.45	0.0354	0.0570
A1	0.00	0.15	0.00	0.0059
A2	0.90	1.30	0.0354	0.0511
b	0.20	0.50	0.0078	0.0196
C	0.09	0.26	0.0035	0.0102
D	2.70	3.10	0.1062	0.1220
E	2.20	3.20	0.0866	0.1181
E1	1.30	1.80	0.0511	0.0708
e	0.95 REF		0.0374 REF	
e1	1.90 REF		0.0748 REF	
L	0.10	0.60	0.0039	0.0236
a°	0°	30°	0°	30°

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

Definitions

Product change

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   1. are intended to implant into the body

or

   2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labelling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

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Product status key:	
"Preview"	Future device intended for production at some point. Samples may be available
"Active"	Product status recommended for new designs
"Last time buy (LTB)"	Device will be discontinued and last time buy period and delivery is in effect
"Not recommended for new designs"	Device is still in production to support existing designs and production
"Obsolete"	Production has been discontinued

Datasheet status key:	
"Draft version"	This term denotes a very early datasheet version and contains highly provisional information, which may change in any manner without notice.
"Provisional version"	This term denotes a pre-release datasheet. It provides a clear indication of anticipated performance. However, changes to the test conditions and specifications may occur, at any time and without notice.
"Issue"	This term denotes an issued datasheet containing finalized specifications. However, changes to specifications may occur, at any time and without notice.

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